IWS-165-YGXWF-N



SPECIFICATION

| Product: YellowGreen SMD LED (1608, 0.5t) Part No.: IWS-165-YGXWF-N Customer: Date: 2009. 04. 02 Ver. 1.0 | | | | | | |
|--|----------------|------------|------------|------------|---------------------------|--|
| | Customer : | | | | | |
| | Checked By | Checked By | Checked By | Checked By | Approval | |
| | | | | | | |
| | Manufacturer : | ITSWELL Co | ., LTD | l I | | |
| | Proposed By | Checked By | Checked By | Checked By | Approval | |
| | | | | | APPROVED 2006. 4. 2 7 Q.A | |
| Comment | | | | | | |
| | | | | | | |



Suwon Company:

442-190, 802 Uman Industrial Comples, 300-5 Uman-dong, Paldal-gu, Gyeonggi-do, Korea Tel:+82-31-244-0002, FAX:+82+31-244-1806

Ochang Company:

363-880, 9-4Block, Ochang Scientific Industrial Complex, Ochang, Cheongwon, Chungbuk, Korea URL: www.itswell.com, TEL: int) 82-43-218-1800, FAX.: int) 82-43-218-1805

IWS-165-YGXWF-N



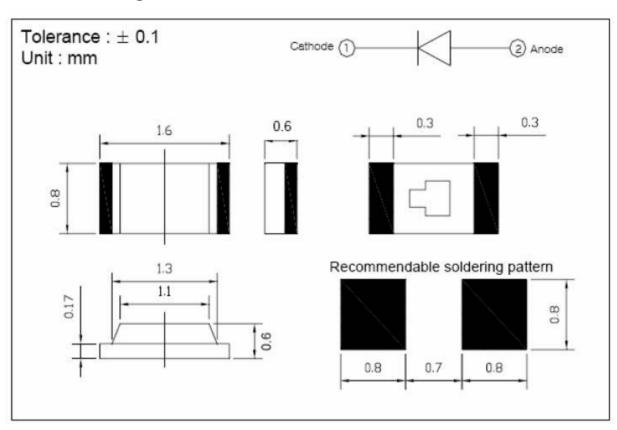
1. Features

- High Luminous Intensity: Long operation life
- Low Current Application : Low power consumption
- Excellent Uniformity on Color, Intensity and Forward Current
- 100% Probing Test

2. Applications

- Telecommunication : Indicator and backlighting in telephone
- Flat Key Pad backlight for Mobile, switch and symbol
- Indoor sign boards
- General Use

3. Outline Drawing and Dimension



IWS-165-YGXWF-N



4. Absolute Maximum Ratings

| Items | Symbols | Ratings | Unit |
|-------------------------------|------------------|------------|------|
| Operation Forward Current | I _F | 20 | mA |
| Peak Pulsed Forward Current*1 | I _{PF} | 60 | mA |
| Power Dissipation | P_{D} | 44 | mW |
| Reverse Voltage | V_R | 5 | V |
| Operating Temperature Range | T _{op} | -30 ~ +85 | °C |
| Storage Temperature Range | T _S | -40 ~ +100 | °C |
| Soldering Temperature | T _{SOL} | 260±5 | °C |

^{*1} Duty ratio = 1/10, Pulse width = 0.1ms

5. Electrical & Optical Characteristics (Ta: 25°C)

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Unit. |
|-----------------------|----------------|-----------------------|------|------|------|-------|
| Forward Voltage | V _F | I _F = 5 mA | 1.6 | 1.8 | 2.2 | V |
| Reverse Current | I _R | V _R = 5 V | - | - | 10 | uA |
| Luminous Intensity*2 | I _V | I _F = 5 mA | 5 | - | 22 | mcd |
| Dominant Wavelength*3 | W_D | I _F = 5 mA | 567 | - | 575 | nm |
| View Angle*4 | 2Θ1/2 | I _F = 5 mA | - | 130 | - | 0 |

^{• 2} Luminous Intensity is tested by a tester calibrated by CAS 140B(CIE LED_B) and has an accuracy of 10%

5.1 Luminous Intensity Rank

| Rank Luminous Intensity (mcc | |
|------------------------------|----------|
| A 5 – 8.5 | |
| В | 8.5 – 10 |
| С | 10 – 15 |
| D | 15 – 22 |

5.3 Forward Voltage Rank

| Rank | Forward Voltage (V) | |
|------|---------------------|--|
| а | 1.6 – 2.2 | |

5.2 Dominant Wavelength Rank

| Rank | Dominant wavelength (nm) | | |
|------|--------------------------|--|--|
| А | 567 – 568 | | |
| В | 568 – 569 | | |
| С | 569 – 570 | | |
| D | 570 – 571 | | |
| Е | 571 – 572 | | |
| F | 572 – 573 | | |
| G | 573 – 574 | | |
| Н | 574 – 575 | | |

| IWS – 165-YGXWF-N | Version of 1. 0 | PAGE: <#> / 10 |
|-------------------|-----------------|----------------|

^{• 3} Dominant wavelength has an accuracy of ± 1 nm.

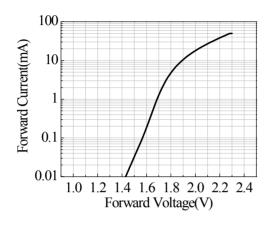
^{• 4} Viewing angle is the angle until 50% of brightness measured from the front part of LED.

IWS-165-YGXWF-N

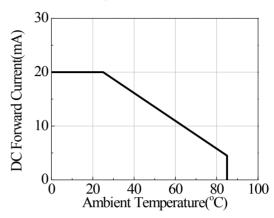


6. Typical Characteristic Curve

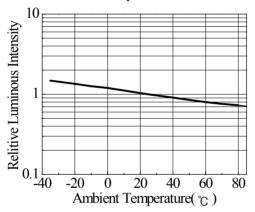
Forward Current vs. Forward Voltage



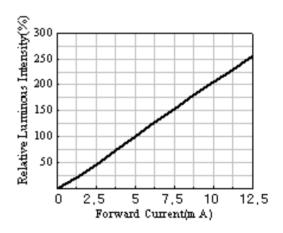
Forward Current vs. Ambient Temperature



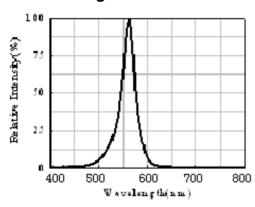
Relative Luminous Intensity vs. Ambient Temperature



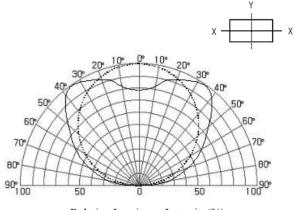
Luminous Intensity vs. Forward Current



Relative Luminous Intensity vs. Wavelength



Radiation Diagram



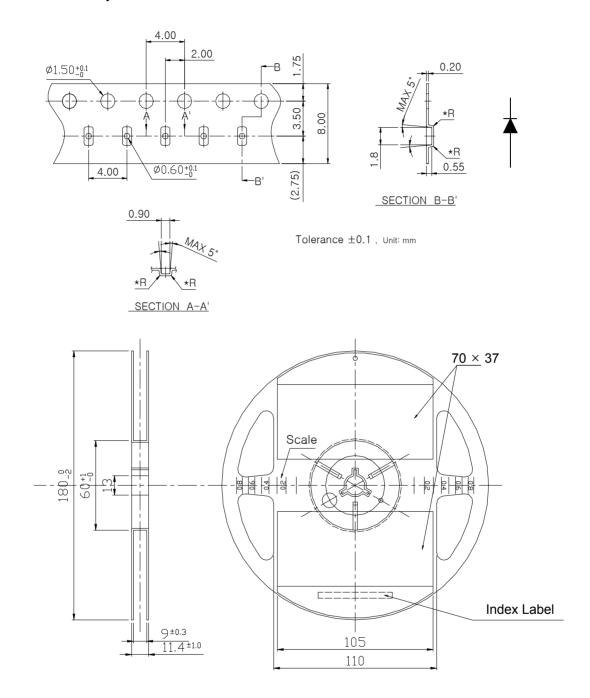
Relative Luminous Intensity(%)

IWS-165-YGXWF-N



7. Dimension of Tape / Reel

Unit : mm



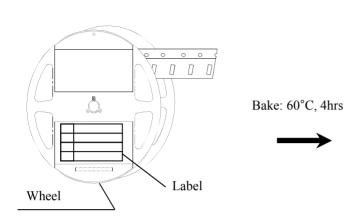
- (1) Quantity: Product are packed in one taping reel of max. 4,000 pcs.
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ± 0.2 mm
- (3) Adhesion Strength of Cover Tape: Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at 10°C angle to be the carrier tape.
- (4) Packaging : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

| IWS – 165-YGXWF-N | Version of 1. 0 | PAGE: <#> / 10 |
|-------------------|-----------------|----------------|
|-------------------|-----------------|----------------|

IWS-165-YGXWF-N

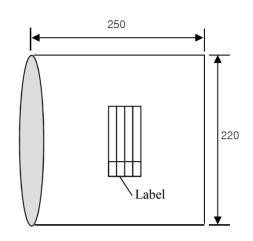


8. Packing Dimension



Diameter: 180 mm Width: 12 mm

1608 ⇒ 4,000 pcs/Reel

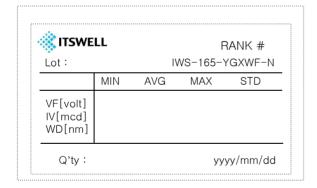


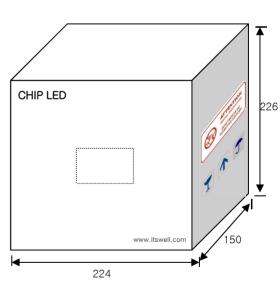
Shield Bag(Al)
1 Reel/Bag (T = 0.1 mm) with Silica gel



Al Pack & Reel Label, Box Label

 (70×37)





Maximum 10 Bags / 1 Inner Box 1608 ⇒ 40,000 pcs / 1 Inner Box

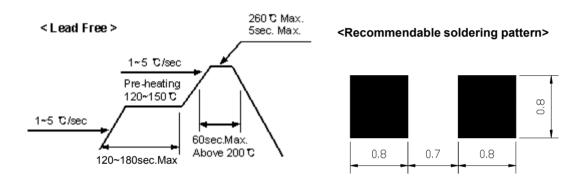
IWS-165-YGXWF-N



9. Precaution in use

9.1 Soldering Conditions

- When soldering SMD LED , Heat may affect the electrical and optical characteristics of the LEDs
- In soldering, do not stress the lead frame and the resin part under the high temperature.
- The epoxy part should be protected from mechanical stress or vibration until the SMD LEDs return to room temperature after soldering.
- Preliminary heating to be at 150 °C max. for 180 Seconds max.
- Soldering heat to be at 260 °C max. for 5 sec. Max.
- For manual Soldering is Not more than 3 sec @MAX 350 °C, under soldering iron



9.2 Storage

■ Use with 7days after opening packing. Store in 10 to 30 °C SMD LED lead frames are plated silver. The silver surface may be affected by environment which contain corrosive gases and so on. Please avoid condition which may cause the SMD LED to corroded, tarnish or discolor.

9.3 Static Electricity

- Static electricity or surge voltage damages the SMD LEDs. It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
- A tip soldering iron is requested to be grounded. An ionizer should also be installed where risk of static.
- All devices, equipment and machinery must be properly grounded (via 1MΩ). It is recommended that measures be taken against surge voltage to the equipment that mounts the SMD LEDs.

9.4 Cleaning

- Isopropyl Alcohol or Ethylene Alcohol is recommended in 5 minutes at room temperature.
 Don't use unspecified chemical may cause crack or haze on the surface of the epoxy resin.
- Before cleaning, a pre-test should be done to confirm whether any damage to the SMD LED will occur.
- Freon solvents should not be used to clean the LEDs because of worldwide regulations.

| IWS – 165-YGXWF-N | Version of 1.0 | PAGE: (#) / 10 |
|-------------------|----------------|----------------|
|-------------------|----------------|----------------|

Topview 1608 Yellow-Green LEDs IWS-165-YGXWF-N



10. Reliability

10.1 Reliability Test Item

| Test Items | Test Conditions | Notes |
|---|---|-------|
| High Temperature Storage | 85 ℃, 500 hr. | 0/32 |
| Low Temperature Storage | -30 ℃, 500 hr. | 0/32 |
| Temp. Humidity Storage | 50 ℃, 95 % RH, 500 hr. | 0/32 |
| Steady State Operating life | 25 ℃ , 5 mA , 500 hr. | 0/32 |
| High Temperature Operating Life | 85 ℃ , 5 mA, 500 hr. | 0/32 |
| Low Temperature Operating Life | -30 ℃ , 5 mA, 500 hr. | 0/32 |
| Steady State Operating life Of High Humidity Heat | 50 ℃, 95 % RH, 5 mA 500 hr. | 0/32 |
| Temperature Cycle | -40 °C (30 min) → 25 °C (5 min.) → 100 °C (30 min.) → 25 °C (5 min.), 100 cycle | 0/22 |
| ESD | HBM, 100pF, 1.5kohm, 3 times (Contact Mode Forward Min 2kV, Reverse Min 200V) | 0/22 |
| Pressure Cooker Test | 121 ℃, 2 atm., 99.6 % RH, 48 hr. | 0/22 |

10.2 Criteria for Judging the Damage

| Items | Test Conditions | Criteria for judgment |
|---------------------------|-----------------------|-----------------------------|
| Luminous Intensity (IV) | I _F = 5 mA | More than > 50% of S |
| Forward Voltage (VF) | I _F = 5 mA | Less than 120% of U |
| Reverse Current (IR) | VR = 5 V | Less than 10 ^µ A |

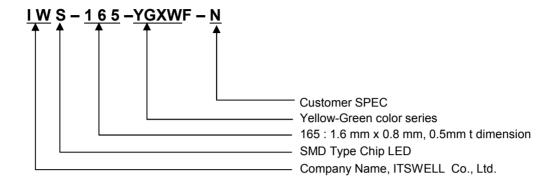
^{*} U means the upper limit of specified characteristics, S means initial value.

| IWS – 165-YGXWF-N | Version of 1. 0 | PAGE: <#> / 10 |
|-------------------|-----------------|----------------|

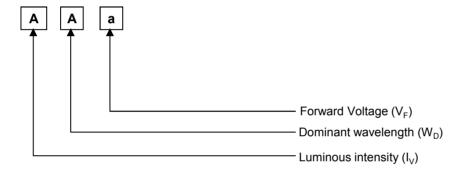
IWS-165-YGXWF-N



11. Part Name Description



12. Rank Description



13. ATTENTION: Electric Static Discharge (ESD) Protection





The symbol shown on the page herein to introduce 'Electro-Optical Characteristics'. ESD protection for GaP and AlGaAs is based chips is still Necessary even though they are safe in low static-electric discharge. Material in AllnGaP, GaP, or/and InGaN based chips are STATIC SENSITIVE devices. ESD protection has to considered and taken in the initial design stage. If manual work/process is needed, please ensure the device is well protective From ESD during all the process.

LED's ESD Level is 'Class II' and The range of Forward Voltage is 2000V ~ 3999V.

After opening the package, the LED's should be kept at 30 ℃, 70%RH or less.

The LEDs must be dip soldered within seven days(168 hours) after opening the moisture-proof packing. It is better not to use different rank LEDs.

If use mixed rank, could not attain your object for highest quality of products.

| IWS – 165-YGXWF-N | Version of 1. 0 | PAGE: <#> / 10 |
|-------------------|-----------------|----------------|

IWS-165-YGXWF-N



■ Spec. Review History

| Review Ver. | Date | Correction List | Etc. |
|-------------|------------|-----------------|------|
| Ver 1.0 | 2009.04.02 | Establish | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |

| IWS – 165-YGXWF-N | Version of 1. 0 | PAGE: <#> / 10 |
|-------------------|-----------------|----------------|
|-------------------|-----------------|----------------|